



#### **General Description**

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

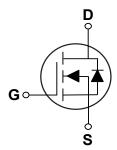
BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Ι <sub>D</sub>
100 V	15 mΩ	41 A

#### **Features**

- $\cdot R_{DS(ON)} \le 15 m\Omega @V_{GS} = 10V$
- · Improved dv/dt Capability
- Fast Switching
- · Green Device Available

#### PPAK5X6 Pin Configuration





#### **Applications**

- Motor Drivers
- DC DC Converter

Symbol	Parameter	Rating	Unit	
$V_{DS}$	Drain-Source Voltage	100	V	
$V_{GS}$	Gate-Source Voltage	±20	V	
I <sub>D</sub>	Drain Current – Continuous (T <sub>C</sub> =25°C)	41	Α	
I <sub>DM</sub>	Drain Current – Pulsed (T <sub>C</sub> =25°C) (NOTE 1)	71	Α	
IAS	Single Pulse Avalanche Energy (L=0.1mH)	18	Α	
EAS	Single Pulse Avalanche Energy (L=0.1mH)	16.2	mJ	
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> =25°C)	46	W	
$T_J$	Operating Junction Temperature	150	°C	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
//arking Code		NM015		

Thermal Characteristics					
Symbol	Symbol Parameter				
$R_{ heta JA}$	Thermal Resistance Junction to Ambient	50	°C/W		
$R_{\theta JC}$	Thermal Resistance Junction to Case	2.7	°C/W		





### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =250uA	100			V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =80V , $V_{GS}$ =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±20V , $V_{DS}$ =0V			±100	nA

#### On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	IStatic Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =10A			15	mΩ
		$V_{GS}$ =4.5V , $I_D$ =8A			25	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	1		3	V
gfs	Forward Transconductance	$V_{DS}$ =5V , $I_{D}$ =20A		22.8		S

#### **Dynamic and switching Characteristics (NOTE 3)**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge			22.5		
$Q_{gs}$	Gate-Source Charge	$V_{DS}$ =50V , $V_{GS}$ =10V , $I_{D}$ =12A		5.29		nC
$Q_{gd}$	Gate-Drain Charge			5.28		
$T_{d(on)}$	Turn-On Delay Time			8.6		
T <sub>r</sub>	Rise Time	$V_{DS}$ =50V , $V_{GS}$ =10V , $R_{GEN}$ =3 $\Omega$ , $I_{D}$ =1A		3.6		nS
$T_{d(off)}$	Turn-Off Delay Time			22.6		113
$T_f$	Fall Time			67.2		
$C_{iss}$	Input Capacitance			1227		
$C_{oss}$	Output Capacitance	$V_{DS}$ =50V , $V_{GS}$ =0V , F=1MHz		382		pF
$C_{rss}$	Reverse Transfer Capacitance			30		
$R_g$	Gate Resistance	V <sub>GS</sub> =0V , V <sub>DS</sub> =0V , F=1MHz		0.9		Ω

### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$V_{SD}$	Diode Forward Voltage (NOTE 2)	$V_{GS}$ =0V , $I_{S}$ =20A			1.1	V

#### NOTES

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width  $\leqq$  300us , duty cycle  $\leqq$  2%.
- 3. Guaranteed by design, not subject to production testing.





#### **Characteristics Curves**

FIG. 1 - Drain Current

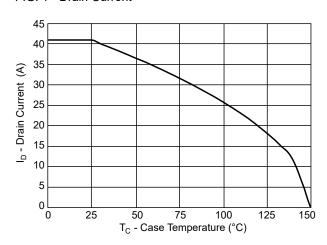


FIG. 2 - Gate Threshold Voltage

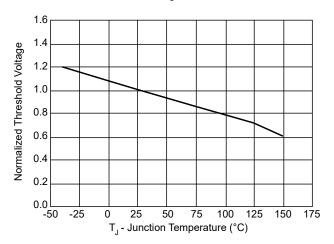


FIG. 3 - Drain-Source On-Resistance

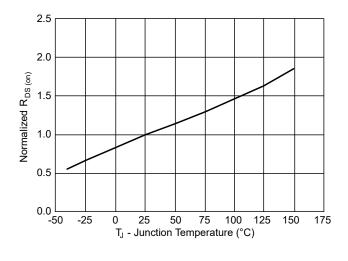


FIG. 4 - Gate Charge Characteristics

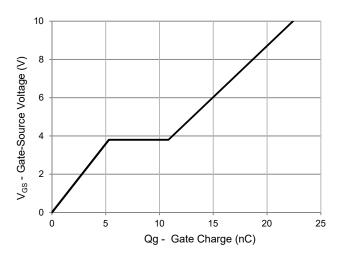


FIG. 5 - Safe Operating Area

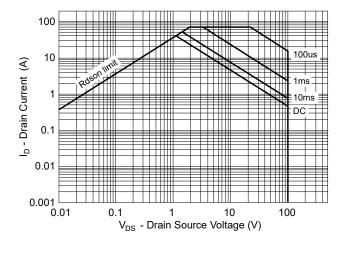
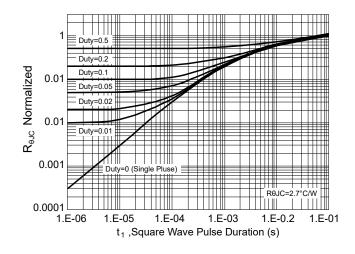


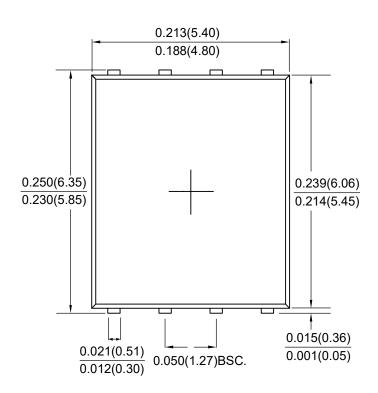
FIG. 6 - Transient Thermal Impedance

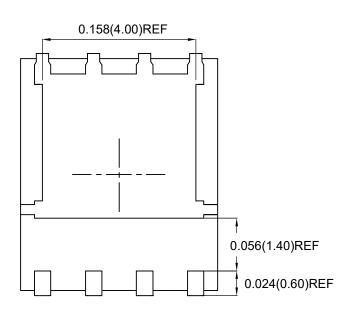


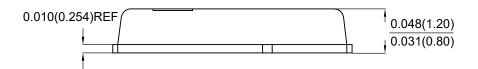


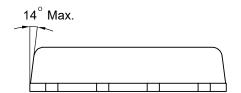


### **Package Outline Dimensions**









PPAK5X6

Dimensions in inches and (millimeters)





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